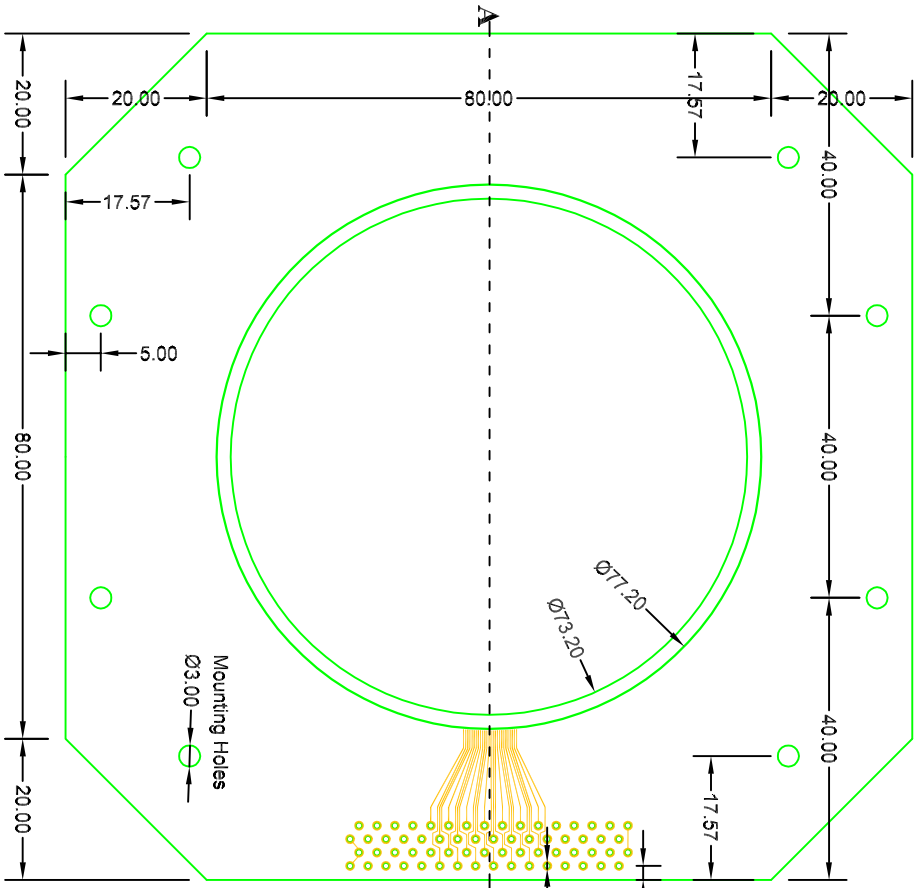
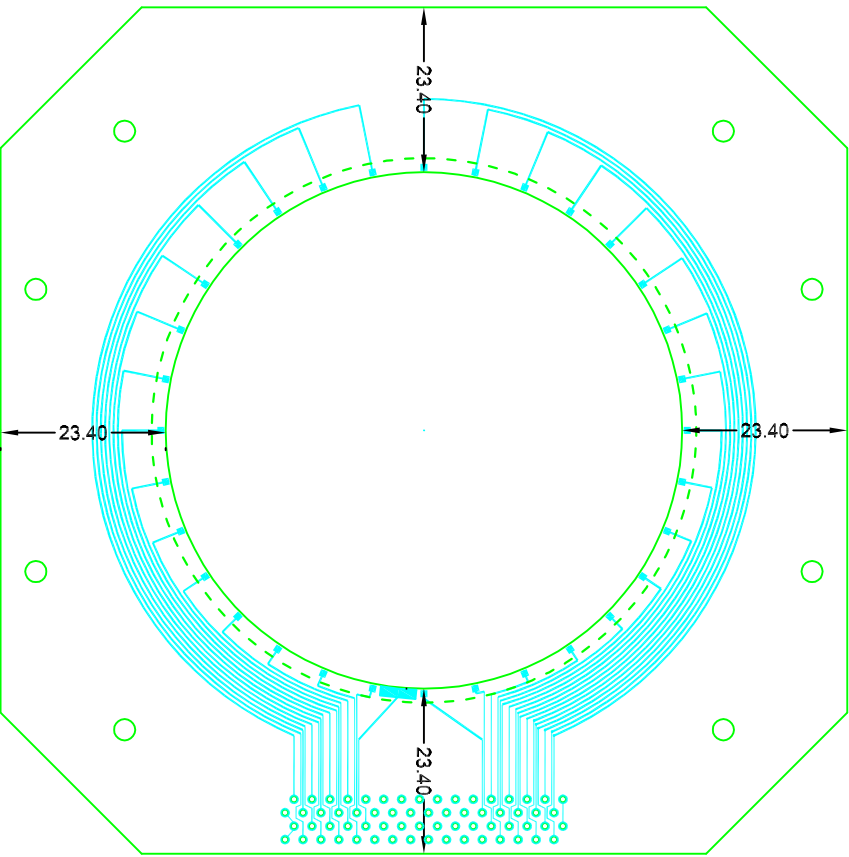


PCB Junction Side Viewed from the Front.



PCB Ohmic Side Viewed Through the PCB from the Junction Side.



PCB Cross Section AA',



CHIP DIAMETER = 76000 um

Key

-  PCB
-  Front Tracking
-  Rear Tracking

Drawn, Checked S.W. A.N.	Date 04/06/2007	Tolerances Unless Stated Package O/D ± 0.1mm Package Hole Ø ± 0.05mm Package Hole Posn ± 0.1mm Material Thickness ± 0.1	Material - Standard FR4 2.40 mm Total Thickness Plating - Soft Au on 1 oz Cu Solder Resist Front - N/A Solder Resist Rear - N/A Ledge - 1.4 mm from Top Surface	Title
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S3 PCB Design.

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Scale 1:1 Dims In. mm Dwg. No. A-3329

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